

## MM54HC132/MM74HC132 Quad 2-Input NAND Schmitt Trigger

### General Description

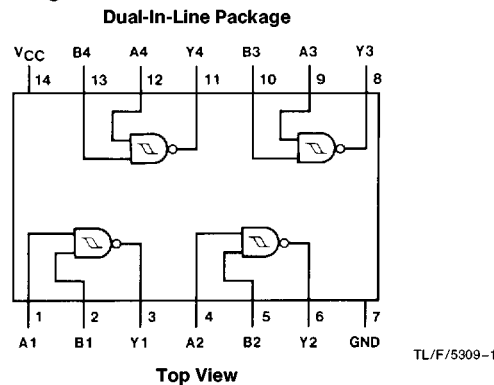
The MM54HC132/MM74HC132 utilizes advanced silicon-gate CMOS technology to achieve the low power dissipation and high noise immunity of standard CMOS, as well as the capability to drive 10 LS-TTL loads.

The 54HC/74HC logic family is functionally and pinout compatible with the standard 54LS/74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to  $V_{CC}$  and ground.

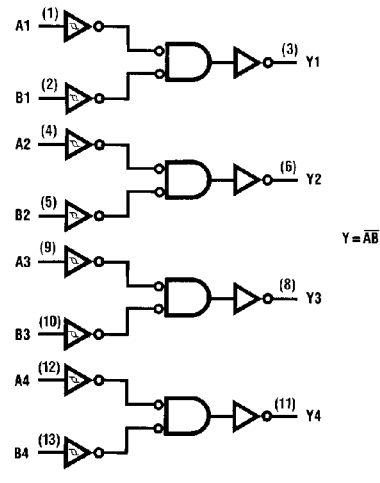
### Features

- Typical propagation delay: 12 ns
- Wide power supply range: 2V–6V
- Low quiescent current: 20  $\mu$ A maximum (74HC Series)
- Low input current: 1  $\mu$ A maximum
- Fanout of 10 LS-TTL loads
- Typical hysteresis voltage: 0.9V at  $V_{CC}=4.5V$

### Connection and Logic Diagrams



### Order Number MM54HC132 or MM74HC132



## Absolute Maximum Ratings (Notes 1 & 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage ( $V_{CC}$ )	-0.5 to +7.0V
DC Input Voltage ( $V_{IN}$ )	-1.5 to $V_{CC} + 1.5V$
DC Output Voltage ( $V_{OUT}$ )	-0.5 to $V_{CC} + 0.5V$
Clamp Diode Current ( $I_{IK}, I_{OK}$ )	$\pm 20$ mA
DC Output Current, per pin ( $I_{OUT}$ )	$\pm 25$ mA
DC $V_{CC}$ or GND Current, per pin ( $I_{CC}$ )	$\pm 50$ mA
Storage Temperature Range ( $T_{STG}$ )	-65°C to +150°C
Power Dissipation ( $P_D$ )	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature ( $T_L$ )	
(Soldering 10 seconds)	260°C

## Operating Conditions

	Min	Max	Units
Supply Voltage ( $V_{CC}$ )	2	6	V
DC Input or Output Voltage ( $V_{IN}, V_{OUT}$ )	0	$V_{CC}$	V
Operating Temp. Range ( $T_A$ )			
MM74HC	-40	+85	°C
MM54HC	-55	+125	°C

## DC Electrical Characteristics (Note 4)

Symbol	Parameter	Conditions	$V_{CC}$	$T_A = 25^\circ\text{C}$		74HC	54HC	Units
				Typ	Guaranteed Limits			
						$T_A = -40$ to $85^\circ\text{C}$	$T_A = -55$ to $125^\circ\text{C}$	
$V_{T+}$	Positive Going Threshold Voltage		Min	2.0V	1.0	1.0	1.0	V
				4.5V	2.0	2.0	2.0	V
				6.0V	3.0	3.0	3.0	V
			Max	2.0V	1.5	1.5	1.5	V
				4.5V	3.15	3.15	3.15	V
				6.0V	4.2	4.2	4.2	V
$V_{T-}$	Negative Going Threshold Voltage		Min	2.0V	0.3	0.3	0.3	V
				4.5V	0.9	0.9	0.9	V
				6.0V	1.2	1.2	1.2	V
			Max	2.0V	1.0	1.0	1.0	V
				4.5V	2.2	2.2	2.2	V
				6.0V	3.0	3.0	3.0	V
$V_H$	Hysteresis Voltage		Min	2.0V	0.2	0.2	0.2	V
				4.5V	0.4	0.4	0.4	V
				6.0V	0.5	0.5	0.5	V
			Max	2.0V	1.0	1.0	1.0	V
				4.5V	1.4	1.4	1.4	V
				6.0V	1.5	1.5	1.5	V
$V_{OH}$	Minimum High Level Output Voltage	$V_{IN} = V_{IH}$ or $V_{IL}$ $ I_{OUT}  \leq 20 \mu\text{A}$	2.0V	2.0	1.9	1.9	1.9	V
			4.5V	4.5	4.4	4.4	4.4	V
			6.0V	6.0	5.9	5.9	5.9	V
			4.5V	4.2	3.98	3.84	3.7	V
			6.0V	5.7	5.48	5.34	5.2	V
$V_{OL}$	Maximum Low Level Output Voltage	$V_{IN} = V_{IH}$ or $V_{IL}$ $ I_{OUT}  \leq 20 \mu\text{A}$	2.0V	0	0.1	0.1	0.1	V
			4.5V	0	0.1	0.1	0.1	V
			6.0V	0	0.1	0.1	0.1	V
			4.5V	0.2	0.26	0.33	0.4	V
			6.0V	0.2	0.26	0.33	0.4	V
$I_{IN}$	Maximum Input Current	$V_{IN} = V_{CC}$ or GND	6.0V		$\pm 0.1$	$\pm 1.0$	$\pm 1.0$	$\mu\text{A}$
$I_{CC}$	Maximum Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu\text{A}$	6.0V		2.0	20	40	$\mu\text{A}$

**Note 1:** Absolute Maximum Ratings are those values beyond which damage to the device may occur.

**Note 2:** Unless otherwise specified all voltages are referenced to ground.

**Note 3:** Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C; ceramic "J" package: -12 mW/°C from 100°C to 125°C.

**Note 4:** For a power supply of 5V  $\pm 10\%$  the worst case output voltages ( $V_{OH}$  and  $V_{OL}$ ) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case  $V_{IH}$  and  $V_{IL}$  occur at  $V_{CC} = 5.5V$  and 4.5V respectively. (The  $V_{IH}$  value at 5.5V is 3.85V.) The worst case leakage current ( $I_{IN}$ ,  $I_{CC}$ , and  $I_{OZ}$ ) occur for CMOS at the higher voltage and so the 6.0V values should be used.

**AC Electrical Characteristics**  $V_{CC}=5V, T_A=25^{\circ}C, C_L=15\text{ pF}, t_r=t_f=6\text{ ns}$

Symbol	Parameter	Conditions	Typ	Guaranteed Limit	Units
$t_{PHL}, t_{PLH}$	Maximum Propagation Delay		12	20	ns

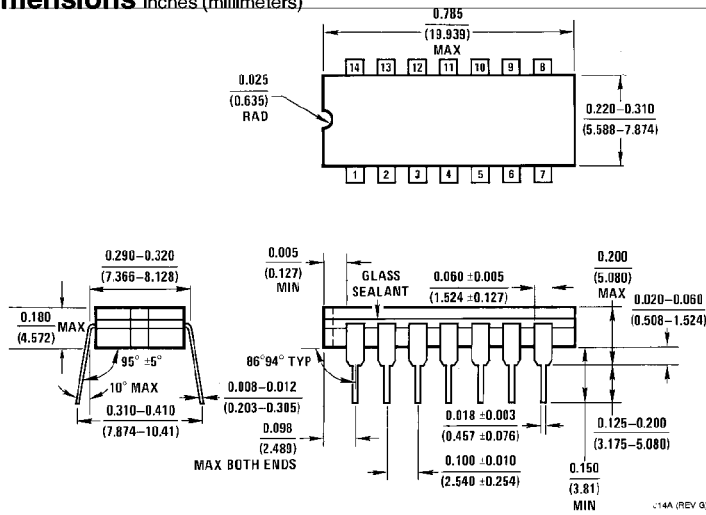
**AC Electrical Characteristics**  $V_{CC}=2.0V\text{ to }6.0V, C_L=50\text{ pF}, t_r=t_f=6\text{ ns}$  (unless otherwise specified)

Symbol	Parameter	Conditions	V <sub>CC</sub>	T <sub>A</sub> = 25°C		74HC	54HC	Units
				Typ	Guaranteed Limits		T <sub>A</sub> = -40 to 85°C	
$t_{PHL}, t_{PLH}$	Maximum Propagation Delay		2.0V	63	125	158	186	ns
			4.5V	13	25	32	37	ns
			6.0V	11	21	27	32	ns
$t_{TLH}, t_{THL}$	Maximum Output Rise and Fall Time		2.0V	30	75	95	110	ns
			4.5V	8	15	19	22	ns
			6.0V	7	13	16	19	ns
C <sub>PD</sub>	Power Dissipation Capacitance (Note 5)	(per gate)		130				pF
C <sub>IN</sub>	Maximum Input Capacitance				5	10	10	pF

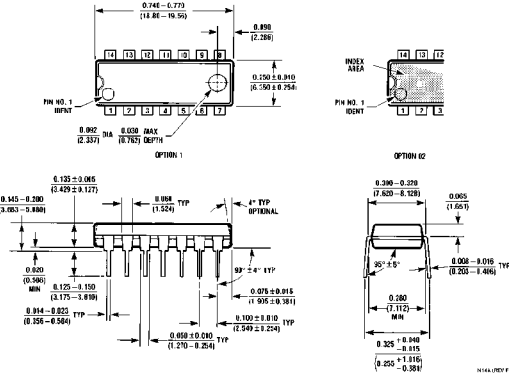
**Note 5:** C<sub>PD</sub> determines the no load dynamic power consumption,  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ , and the no load dynamic current consumption,  $I_S = C_{PD} V_{CC} f + I_{CC}$ .

MM54HC132/MM74HC132 Quad 2-Input NAND Schmitt Trigger

**Physical Dimensions** inches (millimeters)



**Dual-In-Line Package (J)**  
**Order Number MM54HC132J or MM74HC132J**  
**NS Package J14A**




**Dual-In-Line Package (N)**  
**Order Number MM74HC132N**  
**NS Package N14A**

**LIFE SUPPORT POLICY**

NATIONAL'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF NATIONAL SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

 <p><b>National Semiconductor Corporation</b>          1111 West Bardin Road          Arlington, TX 76017          Tel: 1(800) 272-9959          Fax: 1(800) 737-7018</p>	<p><b>National Semiconductor Europe</b>          Fax: (+49) 0-180-530 85 86          Email: cnjwge@tevm2.nsc.com          Deutsch Tel: (+49) 0-180-530 85 85          English Tel: (+49) 0-180-532 78 32          Français Tel: (+49) 0-180-532 93 58          Italiano Tel: (+49) 0-180-534 16 80</p>	<p><b>National Semiconductor Hong Kong Ltd.</b>          13th Floor, Straight Block,          Ocean Centre, 5 Canton Rd.          Tsimshatsui, Kowloon          Hong Kong          Tel: (852) 2737-1600          Fax: (852) 2736-9960</p>	<p><b>National Semiconductor Japan Ltd.</b>          Tel: 81-043-299-2309          Fax: 81-043-299-2408</p>
--	--	---	---

National does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and National reserves the right at any time without notice to change said circuitry and specifications.